

Dual N-Channel Enhancement Mode Field Effect Transistor



General Description

The AO6804 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications. AO6804 is Pb-free (meets ROHS & Sony 259 specifications).

Features

 $V_{DS} = 20V$

 $I_D = 5.0A$ $(V_{GS} = 4.5V)$

Typical Rds

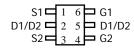
 $R_{DS(ON)} < 24m\Omega (V_{GS} = 4.5V)$

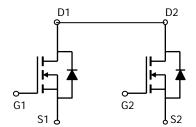
 $R_{DS(ON)}$ < 26m Ω (V_{GS} = 4.0V)

 $R_{DS(ON)} < 28m\Omega (V_{GS} = 3.1V)$

 $R_{DS(ON)}$ < 31m Ω (V_{GS} = 2.5V)

TSOP6 Top View





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	10 Sec	Steady State	Units
Drain-Source Voltage		V_{DS}	20		V
Gate-Source Voltage		V_{GS}	±12		V
Continuous Drain	T _A =25°C		5	4	
Current ^A	T _A =70°C	I_D	4	3.2	Α
Pulsed Drain Current B		I_{DM}	25		
Power Dissipation ^A	T _A =25°C	P _D	1.3	0.8	W
	T _A =70°C		0.8	0.5	VV
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150		°C

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{\scriptscriptstyle{ hetaJA}}$	76	95	°C/W			
Maximum Junction-to-Ambient A	Steady State	IN _θ JΑ	118	150	°C/W			
Maximum Junction-to-Lead ^C	Steady State	$R_{ hetaJL}$	54	68	°C/W			

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
STATIC F	PARAMETERS					
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20V, V _{GS} = 0V			1	μА
		$T_J = 55^{\circ}C$			5	
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 12V$			±500	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_{D} = 250 \mu A$	0.5	0.75	1.2	V
I _{D(ON)}	On state drain current	$V_{GS} = 4.5V, V_{DS} = 5V$	25			Α
R _{DS(ON)}		$V_{GS} = 4.5V, I_D = 5.0A$	18	24	32	C
		T _J =125°C	25	33	43	mΩ
	Static Drain-Source On-Resistance	V _{GS} = 4.0V, I _D = 4.5A	22	26	34	mΩ
		V _{GS} = 3.1V, I _D = 4.5A	21	28	37	mΩ
		V _{GS} = 2.5V, I _D = 4.0A	22	31	42	mΩ
g _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		7		S
V_{SD}	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.65	1	V
I _S	Maximum Body-Diode Continuous Current				1.1	Α
DYNAMIC	CPARAMETERS					
C _{iss}	Input Capacitance			580	725	pF
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		95		pF
C _{rss}	Reverse Transfer Capacitance	1		70		pF
R₀	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		3.5	5.3	Ω
SWITCHI	NG PARAMETERS			•	•	
Q_g	Total Gate Charge			5.8	7.7	nC
Q_{gs}	Gate Source Charge	V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 5A		1		nC
Q_{gd}	Gate Drain Charge	1		1.6		nC
t _{D(on)}	Turn-On DelayTime			2.4		ns
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =10V, R_{L} =2.0 Ω ,		6.4		ns
t _{D(off)}	Turn-Off DelayTime	R_{GEN} =3 Ω		38		ns
t _f	Turn-Off Fall Time	1		9.5		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dI/dt=100A/μs		18	24	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs		6		nC

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ = 25°C. in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating. B: Repetitive rating, pulse width limited by junction temperature.

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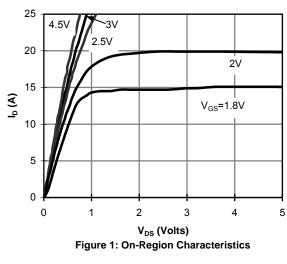
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C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ =25°C. The SOA curve provides a single pulse rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



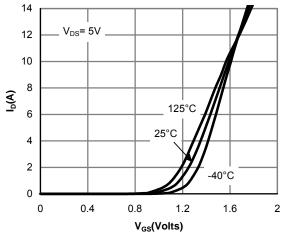


Figure 2: Transfer Characteristics

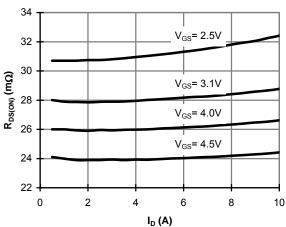


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

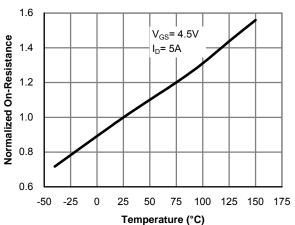


Figure 4: On-Resistance vs. Junction
Temperature

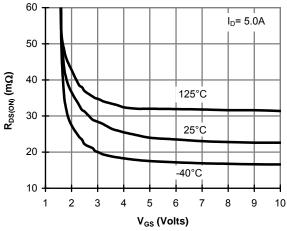


Figure 5: On-Resistance vs. Gate-Source Voltage

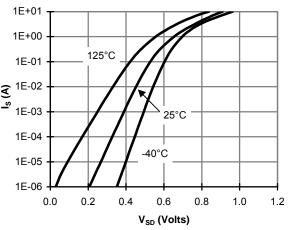
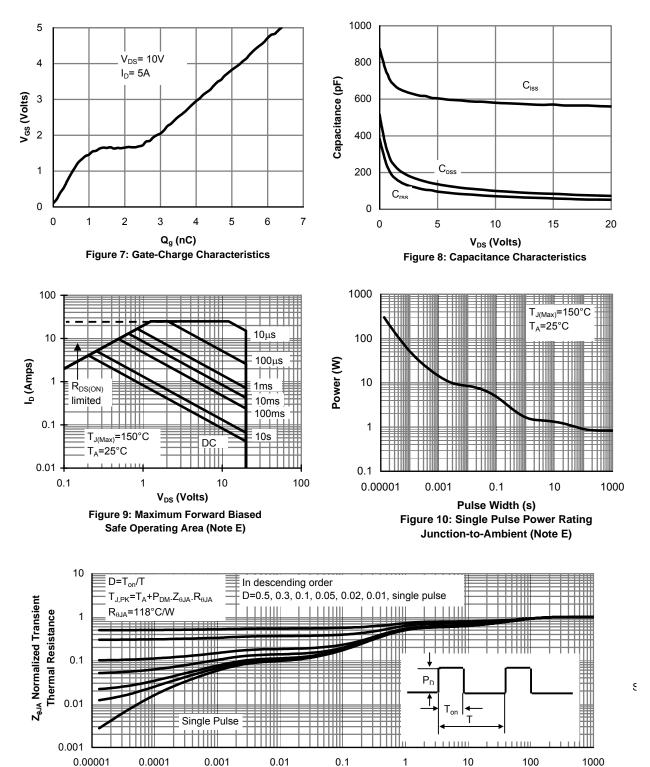


Figure 6: Body-Diode Characteristics

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Pulse Width (s)
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)